

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
		13 andf contact\$3	US-PGPU B; USPAT; EPO; JPO	OR	ON	2004/12/07 09:53
		10 and \$4type	US-PGPU B; USPAT; EPO; JPO	OR	ON	2004/12/07 09:49
L1	1390	(power adj device) with method	US-PGPU B; USPAT; EPO; JPO	OR	ON	2004/12/07 09:42
L2	2257	(power adj device) with (method process manufactur\$4)	US-PGPU B; USPAT; EPO; JPO	OR	ON	2004/12/07 09:43
L3	1082	2 and substrate	US-PGPU B; USPAT; EPO; JPO	OR	ON	2004/12/07 09:43
L4	582	3 and implant\$6	US-PGPU B; USPAT; EPO; JPO	OR	ON	2004/12/07 09:45
L5	500	4 and mask\$4	US-PGPU B; USPAT; EPO; JPO	OR	ON	2004/12/07 09:45
L6	427	5 and (epi epitaxial\$3)	US-PGPU B; USPAT; EPO; JPO	OR	ON	2004/12/07 09:46
L7	374	6 and (window opening pattern\$4)	US-PGPU B; USPAT; EPO; JPO	OR	ON	2004/12/07 09:47
L8	308	7 and channel	US-PGPU B; USPAT; EPO; JPO	OR	ON	2004/12/07 09:47
L9	303	8 and first	US-PGPU B; USPAT; EPO; JPO	OR	ON	2004/12/07 09:47
L10	302	9 and second	US-PGPU B; USPAT; EPO; JPO	OR	ON	2004/12/07 09:48
L11	298	10 and (n p first second) near3 (type conductivity)	US-PGPU B; USPAT; EPO; JPO	OR	ON	2004/12/07 09:51

L12	255	11 and (anneal\$4 thermal\$4 heat\$4)	US-PGPU B; USPAT; EPO; JPO	OR	ON	2004/12/07 09:52
L13	175	11 and (anneal\$4 thermal\$4 heat\$4) with implant\$6	US-PGPU B; USPAT; EPO; JPO	OR	ON	2004/12/07 09:52
L14	169	13 and contact\$3	US-PGPU B; USPAT; EPO; JPO	OR	ON	2004/12/07 09:56
L15	164	14 and source	US-PGPU B; USPAT; EPO; JPO	OR	ON	2004/12/07 09:56
L16	163	15 and drain	US-PGPU B; USPAT; EPO; JPO	OR	ON	2004/12/07 09:57
L17	314805	"17" and gate	US-PGPU B; USPAT; EPO; JPO	OR	ON	2004/12/07 09:57
L18	163	16 and gate	US-PGPU B; USPAT; EPO; JPO	OR	ON	2004/12/07 09:58
L19	155	18 and vertical\$3	US-PGPU B; USPAT; EPO; JPO	OR	ON	2004/12/07 13:12
L20	8	"657082"	US-PGPU B; USPAT; EPO; JPO	OR	ON	2004/12/07 10:13
L21	7	"6507082"	US-PGPU B; USPAT; EPO; JPO	OR	ON	2004/12/07 10:14
L22	1	"6239463".PN.	USPAT; USOCR	OR	ON	2004/12/07 10:52
L23	1	"6172398".PN.	USPAT; USOCR	OR	ON	2004/12/07 10:53
L24	73	19 and low adj voltage	US-PGPU B; USPAT; EPO; JPO	OR	ON	2004/12/07 13:13